MEI Form -1.2, (July 1, 2005)

Docket No.

DECLARA		R OF ATTORNE	Y FOR U.S. PATENT A	
next to my name; and I bel	ieve that I am the origi	inal, first and sole in	ace, post office address and oventor (if only one name is list natter which is claimed and f	sted below) or an original fir
Title: MANUFACTURING	METHOD OF A SEMI	CONDUCTOR DEVI	CE	
the attached specifica	tion, or		the specification of which is a	,
and with amendments	s Application No filed on	·	filed on (if applica	;
the specification in In	temational Application	No. PCT/JP2005/00	(ii applica 5947	wie), or
filed on March 29, 20	05 and as a	amended on	5947 (if applic	able).
	have reviewed and un	derstand the content	s of the above-identified spec	
l acknowledge my o patentability as defined in Ti	duty to disclose to the tle 37, Code of Federa	U.S. Patent and Trac I Regulations, §1.56.	demark Office all information	known to me to be material t
application(s) for patent or i country other than the Unite	inventor's certificate, o d States of America. li	or §365(a) of any PC sted below, and have	States Code, §119 (a-d), §1 T international application we also identified below any fo iling date before that of the a	hich designated at least on
COUNTRY	APPLICA	ATION NO.	DATE OF FILING	PRIORITY CLAIMED
Japan	2004-	103681	March 31, 2004	Yes
	•			
⊃ Additional foreign or interna	ational application num	nbers are listed on a	supplemental priority sheet at	tached hereto.
I hereby claim the listed below.	benefit under Title 35,	United States Code	§119(e) of any United Stat	es Provisional application(s)
Numb	per		(Day/Month/Year Fil	ed)
,	,			
				<u>.</u>

□ Additional U.S. provisional application numbers are listed on a supplemental priority sheet attached hereto.

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I hereby claim the benefit under Title 35, United States Code §120 of any United States application(s), or §365(C) of any PCT international application designating the United States of America, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT international application in the manner provided by the first paragraph of Title 35, United States Code §112, I acknowledge the duty to disclose information material to patentability as defined in Title 37, Code of Federal Regulations, §1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application.

APPLICATION NO.	U.S. FILING DATE	STATUS: PATENTED, PENDING, ABANDONED

a Additional U.S. or international application numbers are listed on a supplemental priority sheet attached hereto.

POWER OF ATTORNEY: As a named inventor, I hereby appoint the attorneys and agents associated with U.S. Patent and Trademark Office Customer Number identified bellow to prosecute this application and to transact all business in the U.S. Patent and Trademark Office connected therewith, and direct that all correspondence be addressed to that customer number.

I hereby authorize the U.S. attorneys and agents associated with the customer number to accept and follow instructions from Matsushita Electric Industrial Co., Ltd., and any affiliated or subsidiary company thereof, received via their corporate representatives and/or their foreign patent attorneys or agents, if any, as to any action to be taken in the U.S. Patent and Trademark Office regarding this application without direct communication between the U.S. attorneys or agents and myself.

Direct	Corres	pondence	to:
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CUSTOMER NUMBER 53080

I further declare that all statements made herein of my own knowledge are true, and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Full Name of Sole or First Inventor	FIRST NAME Satoshi	SHIBATA VII (7//-// 1	F SIGNATURE	
Boolds as 6 Olds as blo				2,2005	
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Full Name of Fifth Inventor	FIRST NAME	LAST NAME	SIGNATURE	DATE O	F SIGNATURE
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Full Name of Sixth Inventor	FIRST NAME	LAST NAME	SIGNATURE DATE OF SIGNATURE		SIGNATURE
Residence & Citizenship	СПҮ	STATE OR COUNTRY		COUNTRY OF	CITIZENSHIP
Post Office Address	ADDRESS	CITY	STATE	OR COUNTRY	ZIP CODE
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(If there are more tha	n seven inventors, plea	se add a copy of this page for ide	entification and sign	ature for the additi	onal
ne above application may be m	nore particularly identifie	ed as follows:			
S. Application No.		Filing Date			
oplicant Reference Number _P	38611-01	Attorney Docket No			